

# **S-26.3120 Radio Engineering, laboratory course**

## **Lab 4: Amplifier**

### **Final Report**

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# Abstract

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# Symbols and abbreviations

## Symbols

$R$	resistance [ $\Omega$ ]
$C$	capacitance [F]
$L$	inductance [H]
$f$	frequency [Hz]
$Z$	impedance [ $\Omega$ ]
$Y$	admittance [S]
$z$	normalized impedance
$y$	normalized admittance
$\lambda$	wavelength [m]
$F$	noise figure [dB]
$G_0$	power gain, equal to $ S_{21} $ [dB]
$G_A$	available power gain [dB]
$G_T$	transducer power gain [dB]
$G_P$	operating power gain [dB]
$L$	attenuation [dB]
$S_{ij}$	scattering parameter from port $i$ to port $j$
$BW$	bandwidth [Hz]
$IIP_n$	$n$ th order input-referred intermodulation intercept point [dBm]
$IM_n$	$n$ th order intermodulation product [dBm]
$ICP$	1 dB input compression point [dBm]
$P$	signal power [dBm]
$N$	noise power [dBm]
$T$	temperature [K]
$w$	transmission line width [m]
$h$	substrate height [m]
$\tan \delta$	“tangent delta”, a merit of substrate quality (attenuation)
$\epsilon_r$	relative permittivity of the substrate
$V$	voltage [V]
$I$	current [I]
$U$	unilateral figure of merit [U]
$\Delta$	determinant of a scattering matrix
$K$	Rollet’s stability factor
$\mu$	stability factor
$\rho$	reflection coefficient
$RL$	return loss [dB]
$l$	transmission line length

## Abbreviations

LNA	low-noise amplifier
SMA	SubMiniature version A, a type of coaxial connector
pHEMT	pseudomorphic high electron mobility transistor, a type of field-effect transistor
RF	radio frequency
DC	direct current
CS	common source, a type of field-effect transistor configuration
IDCS	inductively degenerated common source
PTH	plated-through hole, a via
PCB	printed circuit board
CAD	computer-aided design
ADS	Agilent Advanced Design System, a CAD software

# 1 Introduction

Topic/Field – overview (one paragraph)

Topic/Field – a closer look (one paragraph)

In the fourth lab exercise during the *S-26.3120 Radio Engineering, laboratory course* a low-noise amplifier (LNA) is to be designed, fabricated and measured. The lab was divided into checkpoints as follows. First there was a individually completed pre-study, based on which the actual amplifier was to be designed in groups using computer-aided design (CAD) tools. For this purpose, Agilent Advanced Design System (ADS) was used.

Using ADS, we created a suitable microstrip layout for our amplifier. Next, a third-party manufacturer fabricated a printed circuit board (PCB) according to our specifications. The amplifier was then fabricated using this board, given transistor and miscellaneous components. The amplifier was then tested and measured rigorously. All of this was to be documented in a detailed lab report.

This document is the final report of this lab exercise and is organized as follows. In the section following the introduction, theoretical background governing LNA design is presented briefly. In the third section, the preliminary design used as a the starting point of the group work is shown. Section 4 gives explains the final amplifier designed with ADS in detail. In the two sections following this explanation, measurements and obtained results are presented. The second to last section draws the conclusion. Finally, in the last section, feedback and suggestions to improve this course are given.

## 2 Theoretical background

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### 3 Preliminary design

In this section, the preliminary design used as a starting point for the group work is presented. This presentation is intentionally rather short, presenting only the main points of the manual design procedure and the crude pre-design. For a more complete depiction of the derivation of the amplifier circuit shown in this section, the reader is advised to get acquainted with the pre-study reports.

The preliminary design is based solely on linear (and also otherwise “ideal”) scattering parameter analysis; a process with a direct connection to the theory shown in the previous chapter and in textbooks like [1–3]. The process is manual in the sense that no purpose-built CAD tools were used. Thus it is indeed possible to obtain same results with a “back-of-the-envelope” approach albeit extremely cumbersome. To help with this, a completely self-made Matlab-script was used.

A circuit schematic of the pre-design is shown in Fig. 1. In the three tables following the figure, the key characteristics of the preliminary design are shown. Table 1 presents the reflection coefficients used for matching. These reflection coefficients are realized single shunt-stub matching with transmission line lengths given in Table 2. In Table 3, the obtained key performance metrics are compared with design goals. All design goals are met simultaneously.

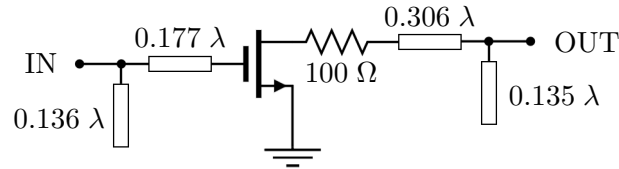


Figure 1: Amplifier pre-design ( $Z_0 = 50 \Omega$ ).

Table 1: Reflection coefficients of the preliminary design.

Reflection coefficient		Cartesian	Polar
Source	$\rho_S$	$-0.191 + j0.461$	$0.499 \angle +112.6^\circ$
Input	$\rho_{in}$	$-0.307 - j0.503$	$0.589 \angle -121.5^\circ$
Load	$\rho_L$	$+0.461 + j0.171$	$0.492 \angle +20.4^\circ$
Output	$\rho_{out}$	$+0.461 - j0.171$	$0.492 \angle -20.4^\circ$

Table 2: Matching circuits of the pre-design ( $Z_0 = 50 \Omega$ ).

Port	Distance from transistor $l_1$ [ $\lambda$ ]	Stub length $l_2$ [ $\lambda$ ]
Input	0.177	0.136
Output	0.306	0.135



Table 3: Properties of the pre-design.

Parameter	Value [dB]	Design goal [dB]	Margin [dB]
$RL_{\text{in}}$	15.22	$\geq 15$	0.22
$RL_{\text{out}}$	$\infty$	$\geq 15$	$\infty$
$G_{\text{A}}$	13.35	$\geq 13$	0.35
$G_{\text{T}}$	13.35	$\geq 13$	0.35
$G_{\text{P}}$	13.49	$\geq 13$	0.49
$F$	0.737	$\leq 0.8$	0.062

## 4 Design

After obtaining a preliminary starting point for the design it was time to pursue the actual design with ADS simulations. In ADS, the final balancing resistor, biasing networks and matching networks were to be designed and optimized. For the simulations, the used PCB material was assigned as RT-Duroid 5870 (Cu 1.0 oz/ft<sup>2</sup>) with  $\epsilon_r = 2.33 \pm 0.02$ ,  $h = 0.787 \pm 0.003$  mm,  $t = 35$   $\mu$ m, and  $\tan \delta = 0.0012$ . The dimensions of the circuit board were  $70 \times 85$  mm<sup>2</sup>. Fig. 2 presents the final amplifier layout. The layout consists of five individual sections, namely, the transistor section (a), input and output biasing networks (a,b) and input and output matching networks (d,e).

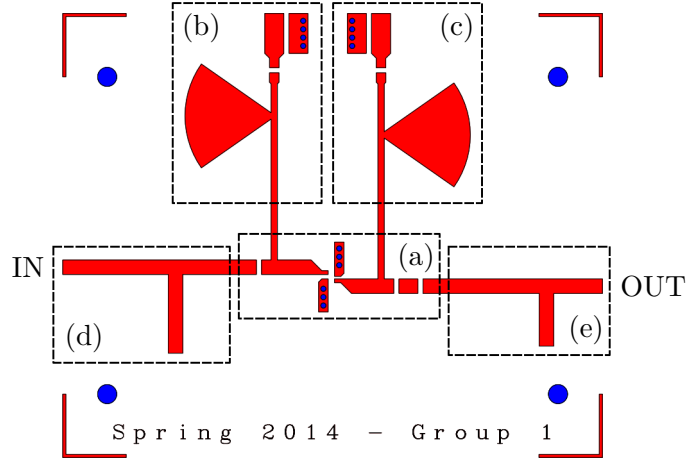


Figure 2: The final amplifier layout comprising (a) transistor section, (b) input biasing, (c) output biasing, (d) input matching and (e) output matching.

The transistor section includes the transistor followed by the stabilizing resistor. The two gaps at the input and output are for the DC blocking capacitors (10 pF, MURATA GQM series). The capacitors prevent the DC power from flowing to the input and output of the amplifier. The lines pointing vertically from the transistor are for the source. The three blue dots on the source lines are the via-grounding holes. Using multiple via-holes lowers the inductance to the ground. An initial value for the balancing resistor was obtained from the preliminary design. The validity of the preliminary design was quickly checked with a S-parameter model of the transistor. The S-parameter model contains the S-parameters of a certainly biased transistor and thus does not require biasing networks. As the preliminary 100  $\Omega$  stabilizing resistor seemed valid it was time to replace the transistor with its non-linear model and continue with the design of the biasing networks.

The biasing networks were designed separately and their operation was verified before attaching them to the actual amplifier model. The main purpose of a biasing networks is to provide DC voltage to empower the transistor. The DC power should not couple to the input and output of the amplifier nor should the RF signal flow to the DC source. Coupling can be avoided by, for instance, using DC blocks, radial stubs, signal absorbing resistors and shorting capacitors. A radial stub, placed at a distance of quarter wavelength from the original signal path, creates a virtual open circuit for the RF signal at a certain frequency. Thus the RF signal does not propagate to the DC source. The absorbing resistor and shorting capacitors

are placed to account for the possible non-desired RF signals. The resistor after the radial stub absorbs the possible reflections whereas the capacitors short the RF signals directly to the ground.  $15\ \Omega$  absorbing resistors were found to be adequate. Three capacitors (1 pF, 10 pF and 100 pF, MURATA GQM series) were used for the shorting. Due to the non-ideality of the capacitors they provide an enhanced shorting to the ground. The grounding was made using four via-holes. The correct biasing gate to source voltage,  $V_{GS}$  was derived with an DC analysis in which the  $V_{GS}$  was swept to result in the required biasing current  $I_{DS}$ . The result of the DC analysis is presented in Fig. 3. Thus the correct biasing was achieved with  $V_{GS} = -0.39\text{ V}$ . The voltage drop due to the absorbing resistor should be accounted by increasing the source DC voltage by the equivalent amount. In the input biasing network the voltage drop is insignificant due to the low current whereas at the output it is significant, namely,  $15\ \Omega \cdot 30\text{ mA} = 0.45\text{ V}$ .

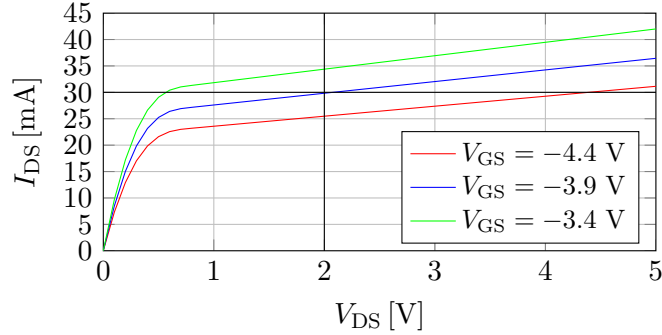


Figure 3: Bias point DC analysis.

After designing the biasing networks they were attached to the amplifier. Correctly designed biasing networks should provide similar simulation results as the S-parameter model of the transistor.

The input and output matching was done using a single open stub. The lengths of the transmission lines were tuned carefully using the Smith chart to meet the design criteria on the amplifier center frequency. At this point, the amplifier did not meet the set gain criteria and thus the value of the balancing resistor had to be decreased. A suitable compromise was found with a balancing resistor value of  $50\ \Omega$ .

Fig. 4 presents the final simulation results for the input and output return losses  $RL$ , stability factor  $K$ , gain  $G$  and noise figure  $F$ . The simulation results depict the amplifier to satisfy all of the set design specifications. The final simulation results at the design frequency at 2.5 GHz are summarized in Table 4.

Table 4: Simulation results at 2.5 GHz

Parameter	Value
$RL_{in}$ [dB]	22.5
$RL_{out}$ [dB]	29.5
$K$	1.5
$G$ [dB]	13.86
$F$ [dB]	0.53

Fig. 5 illustrates the 1 dB gain compression and third order intercept (TOI) point for the

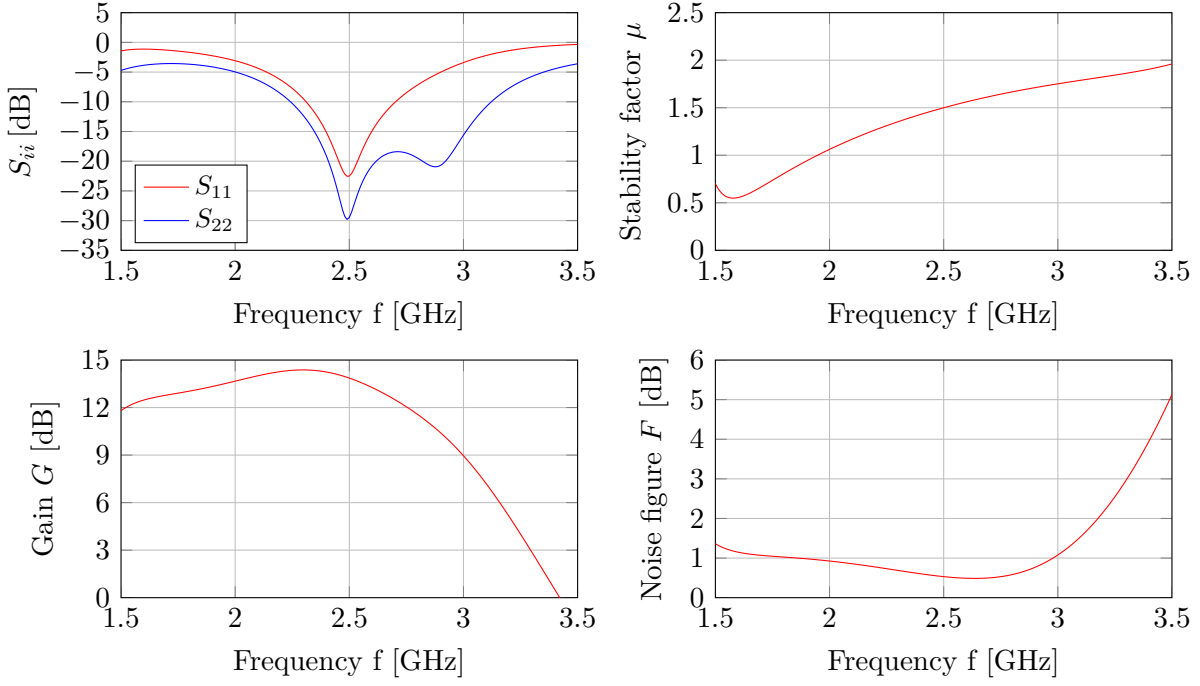


Figure 4: Simulation results for input and output return losses, stability factor, gain and noise.

amplifier. The second and third order intermodulation terms ( $IM_2$  and  $IM_3$ ) are also plotted in addition to the desired signal frequency. The 1-dB gain compression and TOI occur at input power levels of  $-1.3$  dB and  $6.7$  dB, respectively.

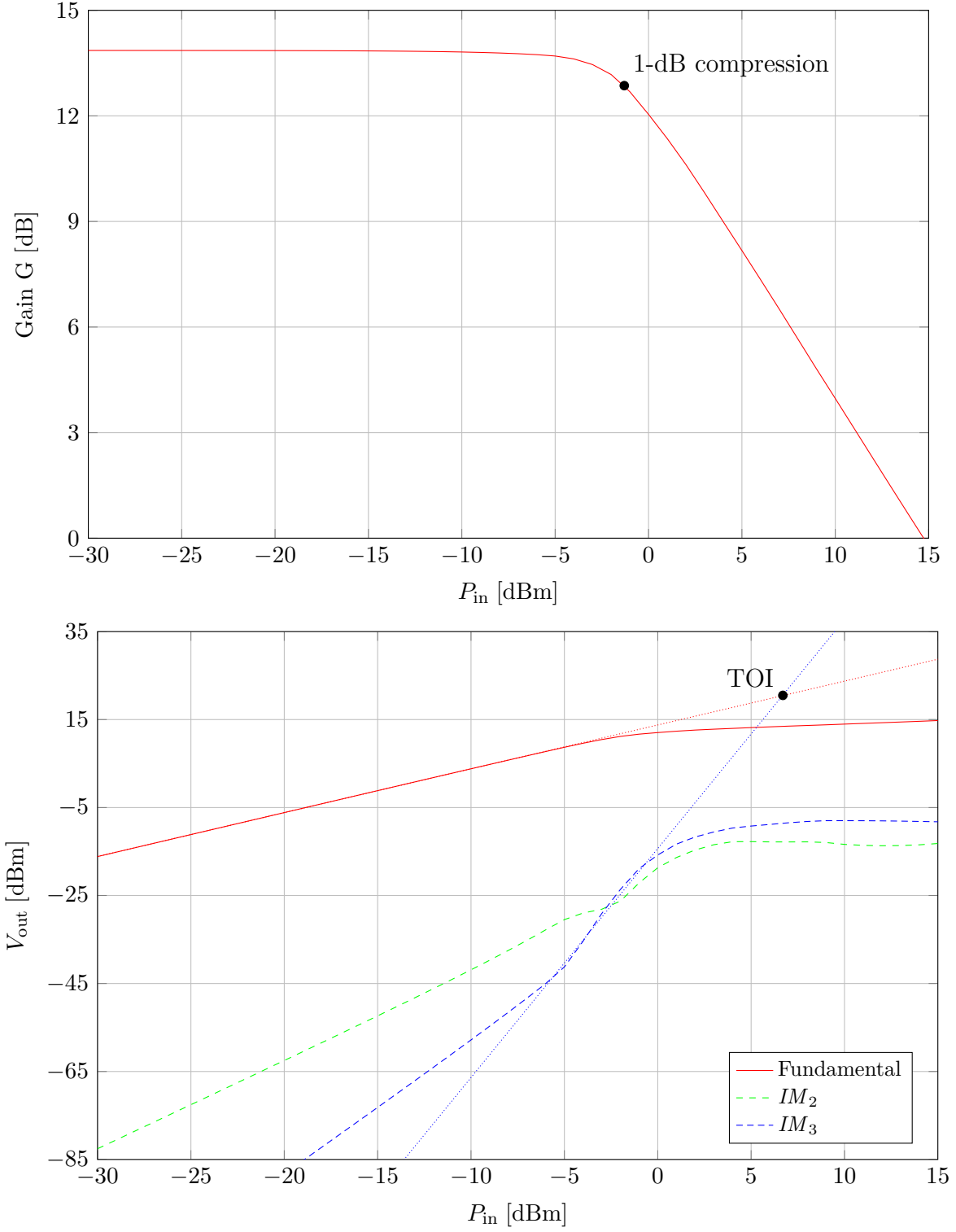


Figure 5: Simulation results for gain saturation and TOI.

## 5 Measurements

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## 6 Results

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## 7 Conclusions

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## 8 Feedback

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## References

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